

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	LOW STRESS CONDUCTIVE POLYMER BUMP							
Application Number :								
Date :								
First Named Applicant:	William E. Bernier							
Confirmation Number:								
Attorney Docket Number:	FIS920040056US1							
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td><td>Sign. Capacity</td></tr><tr><td>James J. Cioffi Registered Number: 51,564</td><td>/James J. Cioffi /</td><td>Attorney</td></tr></table>			Submitted By:	Elec. Sign.	Sign. Capacity	James J. Cioffi Registered Number: 51,564	/James J. Cioffi /	Attorney
Submitted By:	Elec. Sign.	Sign. Capacity						
James J. Cioffi Registered Number: 51,564	/James J. Cioffi /	Attorney						

Documents being submitted:	Files
us-request	FIS920040056US1-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	FIS920040056US1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-ids	FIS920040056US1-usidst.xml us-ids.dtd us-ids.xsl
application-body	FIS920040056ABX.xml application-body.dtd Image1.tif Image2.tif Image3.tif isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isogr1.ent isogr2.ent isogr3.ent isogr4.ent isolat1.ent isolat2.ent isomfrk.ent isomopf.ent isomscr.ent isonum.ent isopub.ent isotech.ent mathml2.dtd mathml2-qname-1.mod mmlalias.ent mmlextra.ent soextblx.dtd us-application-body.xsl wipo.ent
application-body-pdf-wrap	FIS920040056ABX-pdf-wrap.xml
abstract-pdf	FIS920040056ABX-abst.pdf
claims-pdf	FIS920040056ABX-clms.pdf
description-pdf	FIS920040056ABX-desc.pdf
drawings-pdf	FIS920040056ABX-draw.pdf
us-declaration	fis920040056dec1.tif

us-declaration	fis920040056dec2.tif
us-declaration	fis920040056dec3.tif
us-declaration	fis920040056dec4.tif
us-declaration	fis920040056dec5.tif
us-declaration	fis920040056dec6.tif
Comments	